



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 10/620,468  
Confirmation No. .... 8630  
Filing Date .... July 15, 2003  
Inventor .... Dinesh Chopra  
Assignee .... Micron Technology, Inc.  
Group Art Unit .... 2822  
Examiner .... T. Tran  
Customer No. .... 021567  
Attorney's Docket No. .... MI22-2345  
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and  
Integrated Circuits Formed Thereby

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Reference -See Attached Form PTO-1449

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 26 Feb 2007

By:

  
James E. Lake  
Reg. No. 44,854

03/01/2007 AWONDAF1 00000017 10620468  
02 FC:1806  
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Form PTO-1449

U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.  
MI22-2345SERIAL NO.  
10/620,468LIST OF ART CITED BY APPLICANT  
(Use several sheets if necessary)

APPLICANT: Dinesh Chopra et al.

FILING DATE  
July 15, 2003GROUP  
2822

## U.S. PATENT DOCUMENTS

*Examiner's Initials		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						

## FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AJ	JP 6-69270	06/1994	Japan				
	AK							
	AL							

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

	AM		
	AN		
	AO		
EXAMINER		DATE CONSIDERED	

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.